



NEW PRODUCT SPEC SHEET

Model Number: A2

- Recommend for AMD® Opteron™ 6100 Series, Socket G34 Processor
- Passive Heat Sink for One-U Server

Overall Specification:

- Overall Dimension: 115.0 x 75.0 x 27.0 mm
- Mounting Pitch 4.1" (104.1 mm)
- Overall Weight: 520 ± 5g
- Material: Copper 1100 with 180° Skiving Fins
- Thermal Resistance 0.17 to 0.34 °C/W, which depends on System Airflow Rate
- Easy Screw-on Captive Mounting
- Thermal Grease Pre-Printed with GE-Toshiba TIG830SP
- Support CPU Power up to 115 Watts
- Bolster Plate is not included

Performance Chart, A2 Thermal Resistance VS. Airflow Rate

